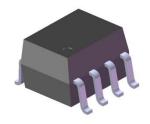


# **DATASHEET**

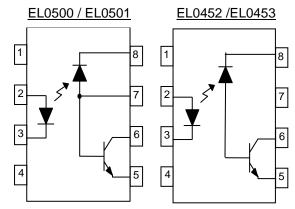
# 8 PIN SOP HIGH SPEED 1Mbit/s TRANSISTOR PHOTOCOUPLER EL045X EL050X Series



#### **Features**

- Compliance Halogen Free (Br <900 ppm ,Cl <900 ppm , Br+Cl < 1500 ppm)</li>
- High speed 1Mbit/s
- 15kV/µs minimum commone mode transient immunity at VCM= 1500V (EL0453)
- High isolation voltage between input and output (Viso=3750 Vrms)
- Guaranteed performance from 0°C to 70°C
- Wide operating temperature range of -55°C to 100°C
- Compliance with EU REACH
- Pb free and RoHS compliant
- UL and cUL approved(No. E214129)
- VDE approved (No. 40028116)
- SEMKO approved
- NEMKO approved
- DEMKO approved
- FIMKO approved Description

## **Schematic**



## Pin Configuration

- 1. No Connection
- 2. Anode
- 3. Cathode
- 4. No Connection
- 5. Gnd
- 6. Vout
- 7. V<sub>B</sub>
- 8. Vcc

#### Pin Configuration

- 1. No Connection
- 2. Anode
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- 5. Gnd
- 6. Vout
- 7. No Connection
- 8. V<sub>CC</sub>

## **Description**

The EL0500, EL0501, EL0452 and EL0453 devices each consist of an infrared emitting diode, optically coupled to a high speed photo detector transistor. A separate connection for the photodiode bias and output-transistor collector increase the speed by several orders of magnitude over conventional phototransistor couplers by reducing the base-collector capacitance of the input transistor. The devices are packaged in an 8-pin small outline package which conforms to the standard SO-8 footprint.

#### **Applications**

- Line receivers
- · Telecommunication equipments
- Power transistor isolation in motor drives
- · Replacement for low speed phototransistor photo couplers
- Feedback loop in switch-mode power supplies
- Home appliances
- · High speed logic ground isolation



# **Absolute Maximum Ratings (Ta=25°C)**

	Parameter		Symbol	Rating	Unit
	Forward current		l <sub>F</sub>	25	mA
	Peak forward current (50% duty, 1ms P.W)		I <sub>FP</sub>	50	mA
Input	Peak transient current (≤1µs P.W,300pps)		I <sub>Ftrans</sub>	1	Α
	Reverse voltage		$V_R$	5	V
	Power dissipation		P <sub>IN</sub>	45	mW
	Power dissipation		Po	100	mW
	Emitter-Base reverse voltage	EL0500 EL0501	$V_{EBR}$	5	V
	Base current	EL0500 EL0501	I <sub>B</sub>	5	mA
Output	Average Output current		$I_{O(AVG)}$	8	mA
	Peak Output current		I <sub>O(PK)</sub>	16	mA
	Output voltage		Vo	-0.5 to 20	V
	Supply voltage		V <sub>CC</sub>	-0.5 to 30	V
Isolation voltage *1			V <sub>ISO</sub>	3750	V rms
Operating temperature			T <sub>OPR</sub>	-55 ~ +100	°C
Storage	temperature	nperature		-55 ~ +125	°C
Soldering	temperature *2		T <sub>SOL</sub>	260	°C

#### **Notes**

<sup>\*1</sup> AC for 1 minute, R.H.=  $40 \sim 60\%$  R.H. In this test, pins 1, 2, 3, 4 are shorted together, and pins 5, 6, 7, 8 are shorted together.

<sup>\*2</sup> For 10 seconds.



# Electrical Characteristics (T<sub>A</sub>=0 to 70°C unless specified otherwise)

Input

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Forward Voltage	$V_{F}$	-	1.45	1.8	V	I <sub>F</sub> =16mA
Reverse Voltage	$V_R$	5.0	-	-	V	I <sub>R</sub> = 10μA
Temperature coefficient of forward voltage	$\Delta V_F / \Delta T_A$	-	-1.9	-	mV/°C	I <sub>F</sub> =16mA

Output

Parameter	Symbol	Min	Тур.	Max.	Unit	Condition
Logic High Output	_	-	0.001	0.5	- μΑ	$I_F=0$ mA, $V_O=V_{CC}=5.5$ V, $T_A=25$ °C
Current	I <sub>OH</sub>	-	0.01	1		$I_F$ =0mA, $V_O$ = $V_{CC}$ =15V, $T_A$ =25°C
	_	-	-	50		I <sub>F</sub> =0mA, V <sub>O</sub> =V <sub>CC</sub> =15V
Logic Low Supply Current	I <sub>CCL</sub>	-	140	200	μΑ	$I_F$ =16mA, $V_O$ =Open, $V_{CC}$ =15V
Logic High Supply		-	0.01	1	μА	$I_F$ =0mA, $V_O$ =0pen, $V_{CC}$ =15V, $T_A$ =25°C
Current	ICCH -	-	-	2		I <sub>F</sub> =0mA, V <sub>O</sub> =Open, V <sub>CC</sub> =15V

Transfer Characteristics (T<sub>A</sub>=0 to 70°C unless specified otherwise)

Parameter		Symbol	Min	Тур.	Max.	Unit	Condition
	EL0500		7	-	50		
Current	EL0501 EL0452 EL0453	. OTD	19	-	50	- %	$I_F = 16\text{mA}$ , $V_O = 0.4\text{V}$ , $V_{CC} = 4.5\text{V}$ , $T_A = 25^{\circ}\text{C}$
Transfer Ratio	EL0500	CTR	5	-	-		
	EL0501 EL0452 EL0453	-	15	-	-		$I_F = 16\text{mA}, V_O = 0.5\text{V}, V_{CC} = 4.5\text{V}$
	EL0500		-	0.18	0.4		$I_F = 16\text{mA}, I_O = 1.1\text{mA}, V_{CC} = 4.5\text{V}, T_A = 25^{\circ}\text{C}$
Logic Low	EL0501 EL0452 EL0453		-	0.18	0.4	V	$I_F = 16mA$ , $I_O = 3mA$ , $V_{CC} = 4.5V$ , $T_A = 25$ °C
Output Voltage	EL0500	V <sub>OL</sub>	-	-	0.5	V	$I_F = 16\text{mA}, I_O = 0.8\text{mA}, V_{CC} = 4.5\text{V}$
	EL0501 EL0452 EL0453		-	-	0.5		$I_F$ = 16mA , $I_O$ =2.4mA, $V_{CC}$ =4.5V



# Switching Characteristics (T<sub>A</sub>=0 to 70°C unless specified otherwise, I<sub>F</sub>=16mA, Vcc=5V)

Parameter		Symbol	Min	Тур.	Max.	Unit	Condition
Propagatio	EL0500		-	-	1.5		R <sub>L</sub> =4.1KΩ, T <sub>A</sub> =25°C
n Delay Time to	ELUSUU	TPHL	-	-	2.0		R <sub>L</sub> =4.1KΩ
Logic Low	EL0501 EL0452	IPAL	-		0.8	- µs	R <sub>L</sub> =1.9KΩ, T <sub>A</sub> =25°C
(Fig.8)	EL0452 EL0453		-	-	1.0		R <sub>L</sub> =1.9KΩ
Propagatio	EL 0500		-	-	1.5		R <sub>L</sub> =4.1KΩ, T <sub>A</sub> =25°C
n Delay	EL0500	TDLU	-	-	2.0	- - μs -	R <sub>L</sub> =4.1KΩ
Time to Logic High	EL0501	TPLH	-	-	0.8		R <sub>L</sub> =1.9KΩ, T <sub>A</sub> =25°C
(Fig.8)	EL0452 EL0453		-	-	1.0		R <sub>L</sub> =1.9KΩ
Common Mode	EL0500	CM <sub>H</sub>	-	1,000	-	- V/μs	$I_F$ = 0mA , $V_{CM}$ =10Vp-p, R <sub>L</sub> =4.1K $\Omega$ , $T_A$ =25°C
Transient Immunity at Logic	EL0452 EL0501		-	1,000	-		$I_F$ = 0mA , $V_{CM}$ =10Vp-p, $R_L$ =1.9K $\Omega$ , $T_A$ =25°C
High (Fig.9)*3	EL0453		15000	-	-		$\begin{split} I_F &= 0 mA \;, \\ V_{CM} &= 1500 Vp\text{-}p \;, \\ R_L &= 1.9 K\Omega \;, T_A \; = 25 ^{\circ} C \end{split}$
Common Mode	EL0500	- CM <sub>L</sub>	-	1,000	-		$\begin{split} I_F = 16\text{mA} \;,\; V_{\text{CM}} = 10\text{Vp-p}, \\ R_L = 4.1\text{K}\Omega,\; T_{\text{A}} = 25^{\circ}\text{C} \end{split}$
Transient Immunity at Logic Low (Fig.9)*3	EL0452 EL0501		-	1,000	-	V/µs	$I_F = 16\text{mA}$ , $V_{CM} = 10\text{Vp-p}$ , $R_L = 1.9\text{K}\Omega$ , $T_A = 25^{\circ}\text{C}$
	EL0453		15000	-	-		$I_F$ = 16mA, $V_{CM}$ =1500Vp-p, $R_L$ =1.9K $\Omega$ , $T_A$ =25°C

<sup>\*</sup> Typical values at T<sub>a</sub> = 25°C



### **Typical Electro-Optical Characteristics Curves**

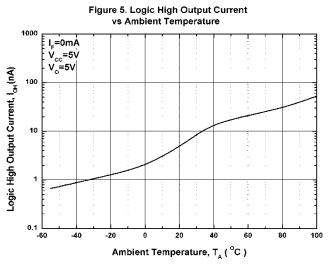


Figure 2. Current Transfer Ratio vs Forward Current

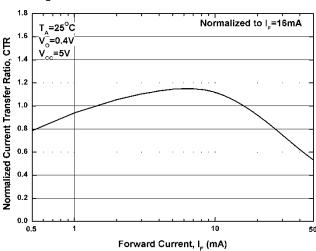


Figure 4. Output Current vs Output Voltage

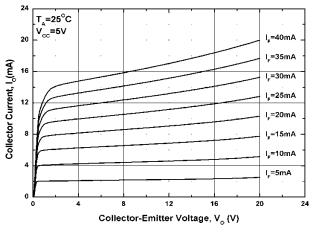


Figure 1. Forward Current vs Forward Voltage

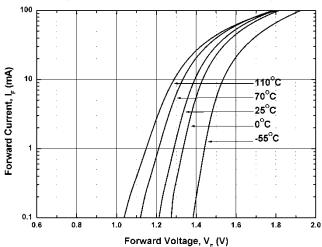


Figure 3. Current Transfer Ratio vs

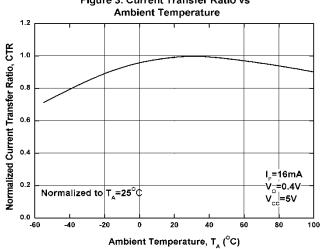
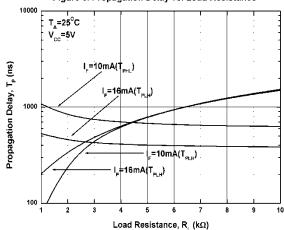


Figure 6. Propagation Delay vs. Load Resistance



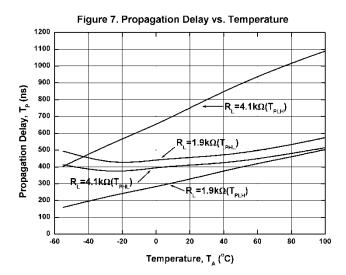


Figure 8 Switching Time Test Circuit & Waveform

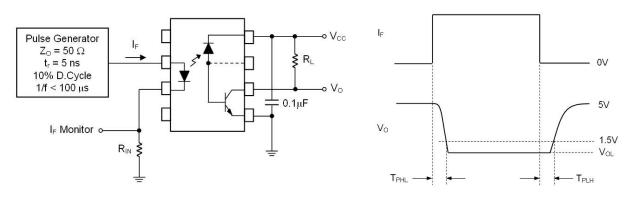
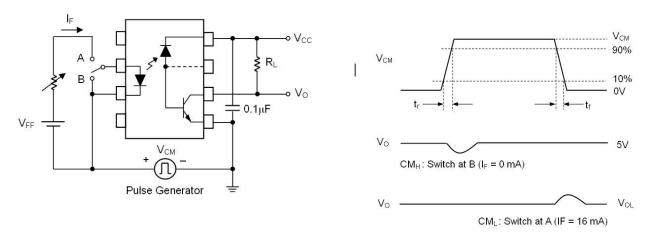


Figure 9 Transient Immunity Test Circuit & Waveform





#### Note:

\*3 Common mode transient immunity in logic high level is the maximum tolerable (positive) dVcm/dt on the leading edge of the common mode pulse signal VCM, to assure that the output will remain in a logic high state (i.e., VO > 2.0V).

Common mode transient immunity in logic low level is the maximum tolerable (negative) dVcm/dt on the trailing edge of the common mode pulse signal, VCM, to assure that the output will remain in a logic low state (i.e., VO < 0.8V).

#### **Order Information**

**Part Number** 

or EL050X(Z)-V EL045X(Z)-V

#### Note

X = Part No. (X = 0 or 1) for EL050x; (x=2 or 3) for EL045x

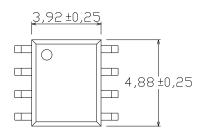
Z = Tape and reel option (TA, TB or none)

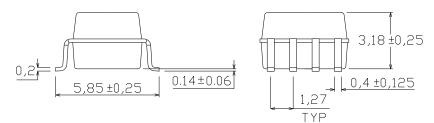
V = VDE (optional)

Option	Description	Packing quantity
None	Standard	100 units per tube
-V	Standard + VDE	100 units per tube
(TA)	TA tape & reel option	2000 units per reel
(TB)	TB tape & reel option	2000 units per reel
(TA)-V	TA tape & reel option + VDE	2000 units per reel
(TB)-V	TB tape & reel option + VDE	2000 units per reel

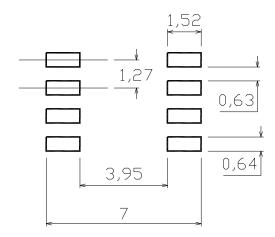


# Package Drawing (Dimensions in mm)



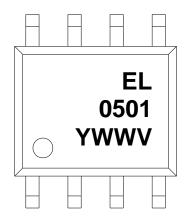


# Recommended pad layout for surface mount leadform





# **Device Marking**



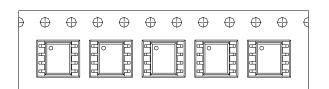
#### **Notes**

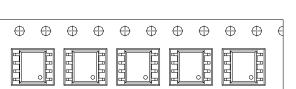
EL denotes EVERLIGHT
0501 denotes Device Number
Y denotes 1 digit Year code
WW denotes 2 digit Week code
V denotes VDE (optional)



**Tape & Reel Packing Specifications** 

## **Option TA**





**Option TB** 

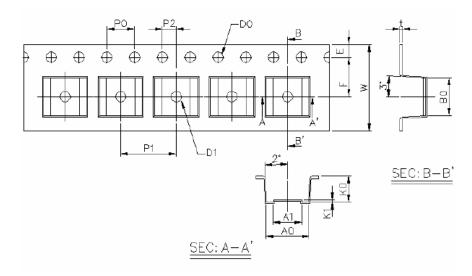




Direction of feed from reel

Direction of feed from reel

## **Tape dimensions**



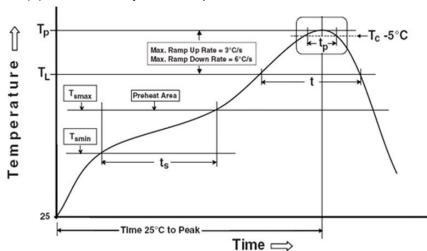
Dimension No.	Α0	A1	В0	D0	D1	E	F
Dimension(mm)	6.2±0.1	4.1±0.1	5.28±0.1	1.5±0.1	1.5±0.3	1.75±0.1	5.5±0.1
Dimension No.	Ро	P1	P2	t	w	K0	K1
Dimension(mm)	4.0±0.1	8.0±0.1	2.0±0.1	0.4±0.1	12.0+0.3/ -0.1	3.7±0.1	0.3±0.1



#### **Precautions for Use**

#### 1. Soldering Condition

1.1 (A) Maximum Body Case Temperature Profile for evaluation of Reflow Profile



Note:

Reference: IPC/JEDEC J-STD-020D

## **Preheat**

Temperature min (T <sub>smin</sub> )	150 °C
Temperature max (T <sub>smax</sub> )	200°C
Time $(T + to T) (t)$	60-120

 $\begin{array}{ll} \text{Time } (T_{smin} \text{ to } T_{smax}) \text{ } (t_s) & 60\text{-}120 \text{ seconds} \\ \text{Average ramp-up rate } (T_{smax} \text{ to } T_p) & 3 \text{ °C/second max} \end{array}$ 

Other

Ramp- Down Rate from Peak Temperature 6°C /second max.

Time 25°C to peak temperature 8 minutes max.

Reflow times 3 times



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